

Title (en)

LASER WELDING DEVICE AND LASER WELDING METHOD

Title (de)

LASERSCHWEISSVORRICHTUNG UND LASERSCHWEISSVERFAHREN

Title (fr)

DISPOSITIF DE SOUDAGE AU LASER ET PROCÉDÉ DE SOUDAGE AU LASER

Publication

EP 3922397 A1 20211215 (EN)

Application

EP 20777947 A 20200310

Priority

- JP 2019064957 A 20190328
- JP 2020010402 W 20200310

Abstract (en)

A laser welding method includes a laser beam irradiation step of oscillating a laser beam and condensing the laser beam on a welding portion, and a scanning step of scanning a spot of the laser beam. In the execution of laser welding, while oscillating the laser beam, a screw portion having a dot shape in a plan view is formed in which a metal member is melted by scanning of the spot so as to circle around a predetermined position, and while the metal member in the screw portion is in a molten state, a linear portion being linear in a plan view and continuous with the screw portion is formed in which a metal member is melted by scanning of the spot so as to be separated from the screw portion.

IPC 8 full level

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CPC (source: EP US)

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AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)

BA ME

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EP 3922397 A1 20211215; **EP 3922397 A4 20220511**; **EP 3922397 B1 20240403**; CN 113573839 A 20211029; CN 113573839 B 20230811; JP 2020163411 A 20201008; JP 6999946 B2 20220119; MX 2021010962 A 20211013; US 2022152736 A1 20220519; WO 2020195806 A1 20201001; WO 2020195806 A9 20210826

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